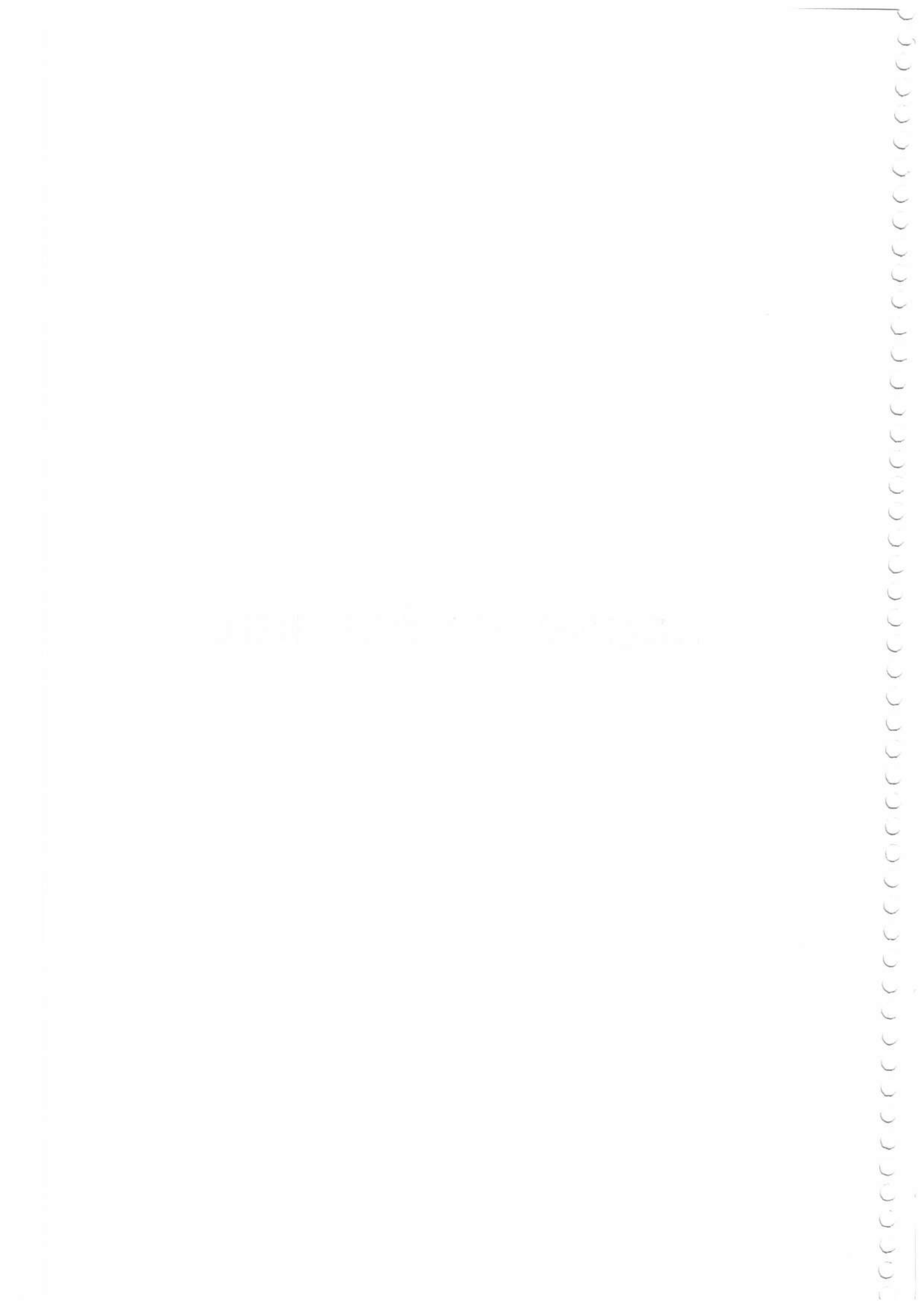


# **DOCUMENTAÇÕES - DELL**



# Dell EMC PowerEdge T440

## Technical Guide

Regulatory Model: E30S Series  
Regulatory Type: E30S002  
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**DELL**Technologies

## Notes, cautions, and warnings

 **NOTE:** A NOTE indicates important information that helps you make better use of your product.

 **CAUTION:** A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

 **WARNING:** A WARNING indicates a potential for property damage, personal injury, or death.

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## System overview

The Dell EMC PowerEdge T440 tower server delivers powerful 2-socket performance, expandability and quiet operations to your small-to mid-sized business (SMB) and remote office/branch office (ROBO) sites. The T440 brings you flexibility with a rackable tower form factor, short 22-inch depth and quiet acoustics that are right for your office or data center.

The PowerEdge T440 is an excellent fit for a wide range of office workloads, including work group collaboration and productivity applications, mail and messaging, file and print serving, and web serving.

### Topics:

- Introduction
- New technologies

## Introduction

The PowerEdge T440 is Dell EMC's latest 2-socket, rackable tower (5U rack) server is a powerful general-purpose platform capable of handling demanding workloads and applications. In addition, the T440 also provides extraordinary storage capacity options, making it well-suited for data-intensive applications that require greater storage, while not sacrificing I/O performance.

The systems feature the 2nd Generation Intel® Xeon® Processor Scalable family with up to 16 DIMMs, PCI Express® (PCIe) 3.0 enabled expansion slots.

Very large internal storage capacity for this class of server - up to 8 x 3.5 -inch HDD or 16 x 2.5 -inch HDD - allows storage inside the chassis, eliminating the need to acquire, cable, power and manage an external storage device.

Virtualization-ready with up to 2 powerful processors, large memory capacity (16 DDR4 DIMMs) and 5 PCIe Gen3 I/O slots for data transfer, and Failsafe Hypervisor protection.

Simplified, intuitive systems management that saves time, save money, and reduces potential for error.

The T440's primary emphasis is SMB & Retail/remote office usage in a non-datacenter environment that provides a lighter workload platform than the T640 tower server. It is a replacement of the previous generation Dell EMC PowerEdge T430 tower server.

The T440 is an ideal solution for:

- Small and Medium Business
- Offices of small- to medium Public organizations
- ROBO of large enterprises and organizations
- Data centers of SMB, Enterprises and Public organizations

## New technologies

The following are the new technologies featured on the PowerEdge T440:

**Table 1. New technologies**

New technology	Detailed description
2nd Generation Intel® Xeon Scalable Processor	<p>The processor product family has embedded PCIe lanes for improved I/O performance.</p> <ul style="list-style-type: none"> <li>• 14nm process technology</li> <li>• Intel® Ultra Path Interconnect (UPI)</li> <li>• Up to 28 cores</li> <li>• Up to 3.8 GHz</li> <li>• Max TDP: 125 W</li> </ul>

Table 1. New technologies (continued)

New technology	Detailed description
Intel C620 series chipset	Intel Platform Controller Hub (PCH).
2666 MT/s DDR4 memory	<ul style="list-style-type: none"> <li>• Support up to 16 DIMMs</li> <li>• Speed of up to 2666 MT/s depending on the CPU.</li> <li>• Support flexible memory configuration of 8 GB to 768 GB in balanced memory configuration. Up to 1 TB maximum in an unbalanced memory configuration.</li> <li>• CPU1 support up to 10 DIMMs</li> <li>• CPU2 support upto 6 DIMMs</li> </ul>
iDRAC9 with Lifecycle Controller	The new embedded systems management solution for the Dell EMC systems features hardware and firmware inventory and alerting, data center level power monitoring, and faster performance.

## System features

Compared to previous generations, the PowerEdge T440 offers faster processing power and advanced system management.

The T440 system is a powerhouse 2S/5U tower system, which emphasizes performance and reliability in areas such as virtualization, power, thermal and systems management, and usability. It is designed for SMB and ROBO sites that require a balance of capacity and performance.

### Topics:

- [Product comparison](#)

## Product comparison

Table 2. Feature comparison

5U Tower Feature	PowerEdge T440	PowerEdge T430
<b>Processors</b>	Second-Generation Intel® Xeon® Processor Scalable Family	Intel® Xeon® Processor E5- 2600 v4
<b>Chipset</b>	Intel C620	Intel C610
<b>Memory</b>	Up to 16x DDR4 RDIMMs (10+6)	Up to 12x (8+4) DDR4 RDIMMs
<b>Storage</b>	Front: <ul style="list-style-type: none"> <li>• 4 or 8 x 3.5 -inch or</li> <li>• 16 x 2.5 -inch</li> <li>• Optional optical drive</li> </ul> Internal: <ul style="list-style-type: none"> <li>• IDSDM + vFlash or</li> <li>• BOSS (2 internal M.2)</li> </ul> Bandwidth: <ul style="list-style-type: none"> <li>• 12 Gb SAS/6 Gb SATA</li> </ul>	Front: <ul style="list-style-type: none"> <li>• 4 or 8 x 3.5 -inch or</li> <li>• 16 x 2.5 -inch</li> <li>• Optional optical drive</li> </ul> Internal: <ul style="list-style-type: none"> <li>• IDSDM</li> </ul> Bandwidth: <ul style="list-style-type: none"> <li>• 12 Gb SAS/6Gb SATA</li> </ul>
<b>PCIe slots</b>	Up to 5 X PCIe Gen3	Up to 4 x PCIe Gen3 + up to 2 x PCIe Gen2 + dedicated PERC slot
<b>GPU support</b>	1x DW 300 W GPU supported 150 W	2x DW 300 W GPU tested
<b>Storage Controller</b>	<b>Software RAID:</b> <ul style="list-style-type: none"> <li>• S140</li> </ul> <b>Internal controllers:</b> <ul style="list-style-type: none"> <li>• H750</li> <li>• H350</li> <li>• H740P</li> <li>• H730P</li> <li>• H330</li> </ul> <b>External controllers:</b> <ul style="list-style-type: none"> <li>• HBA355e</li> <li>• H840</li> <li>• 12 Gb/s Ext SAS HBA</li> </ul> <b>SAS Hot Bus Adapters:</b> <ul style="list-style-type: none"> <li>• HBA350i</li> <li>• HBA 330</li> </ul>	<ul style="list-style-type: none"> <li>• S130, H330, H730, H730P, H810/H830 (ext)</li> <li>• Chipset SATA/SW RAID: Yes</li> </ul>

Table 2. Feature comparison (continued)

5U Tower Feature	PowerEdge T440	PowerEdge T430
<b>Embedded NIC</b>	2x 1 GbE (LOM : BCM5720)	2x 1 GbE (LOM : BCM5720)
<b>Power Supplies</b>	<ul style="list-style-type: none"> <li>• 495 W AC Platinum</li> <li>• 750 W AC Platinum</li> <li>• 750 W AC Titanium</li> <li>• 1100 W AC Platinum</li> </ul>	<ul style="list-style-type: none"> <li>• 495 W AC Platinum</li> <li>• 750 W AC Platinum</li> <li>• 750 W AC Titanium</li> <li>• 1100 W AC Platinum</li> <li>• 1600 W Platinum</li> </ul>
<b>Remote Management</b>	iDRAC9	iDRAC8
<b>TPM</b>	TPM China, TPM1.2, TPM2.0	TPM China, TPM1.2, TPM2.0
<b>iDRAC port</b>	Dedicated port (RJ45)	Micro USB
<b>Fan</b>	Up to two fans supported <ul style="list-style-type: none"> <li>• Internal Fan (1X4 type)</li> <li>• External Fan (1X5 type)</li> </ul>	Up to two fans supported <ul style="list-style-type: none"> <li>• Internal Fan (1X4 type)</li> <li>• External Fan (1X5 type)</li> </ul>
<b>Standard rear ports</b>	<ul style="list-style-type: none"> <li>• 2 x RJ45 1GE LAN ports</li> <li>• Rear system ID button</li> <li>• iDRAC Enterprise Port (RJ45 port)</li> <li>• Six USBs (4XUSB2.0 ; 2XUSB3.0)</li> </ul>	<ul style="list-style-type: none"> <li>• 2 x RJ45 1GE LAN ports</li> <li>• Rear system ID button</li> <li>• CMA external LED jack</li> <li>• iDRAC Enterprise Port (RJ45 port)</li> <li>• Two USBs (1xUSB2.0, 1xUSB3.0)</li> <li>• DB-15 VGA; DB-9</li> <li>• Serial; VFlash socket</li> </ul>
<b>PERC</b>	PCIe PERC 9 or PERC 10 or PERC 11	Mini-PERC 9



## Chassis views and features

The PowerEdge T440 is a two socket, 5U tower system that is available in three different chassis configurations:

- 4 hard drive chassis
- 8 hard drive chassis
- 16 hard drive chassis

### Topics:

- Front panel view and features
- Back view of the system
- Internal chassis view
- Security features



## Front panel view and features

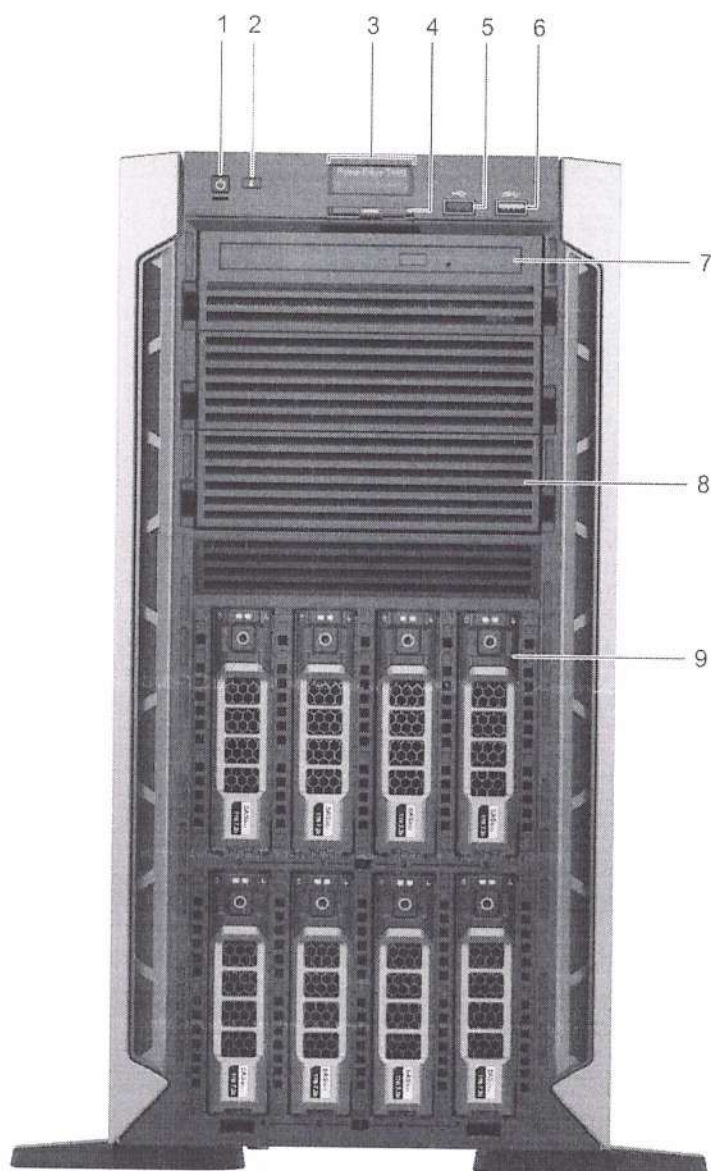


Figure 1. Front panel view of a 8 x 3.5-inch hot swappable drive system

Table 3. Front panel features





Item	Components - Indicator, Button, or Connector	Icon	Description
1	Power button		Indicates if the system is powered on or off. Press the power button to manually power on or off the system.  ① <b>NOTE:</b> Press the power button to gracefully shut down an ACPI-compliant operating system.
2	System identification button		The System Identification (ID) button is available on the front and back of the systems. Press the button to identify a system in a rack by

Table 3. Front panel features (continued)

Item	Components - Indicator, Button, or Connector	Icon	Description
			turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode.
3	Status LED indicator panel	N/A	Indicate the status of the system. For more information, see the Status LED indicators section.
4	Information tag	N/A	The Information tag is a slide-out label panel that contains system information such as Service Tag, NIC, MAC address, and so on. If you have opted for the secure default access to iDRAC, the Information tag also contains the iDRAC secure default password.
5	USB port 2.0		The USB ports are 4-pin, 2.0-compliant. These ports enable you to connect USB devices to the system.
6	USB port 3.0		The USB port is USB 3.0 compliant.
7	Optical drive bay	N/A	Enable you to install drives that are supported on your system. For more information about drives, see the Technical specifications section.
8	Drive slot	N/A	Enables you to install TBUs for 8x and 16x backplane configurations, or drive blank in the empty drive slot to maintain proper system cooling.
9	Physical drives	N/A	3.5 inch drives and 2.5 inch drives/SSDs.

## Back view of the system

The back panel of a PowerEdge system contains access to I/O connectors for both embedded and add-in devices, including networking, video, serial, USB, system ID, and system management access ports. Most add-in PCI cards are accessible through the back panel. It is also the default location for power supply units (PSU), including the points for AC connections.

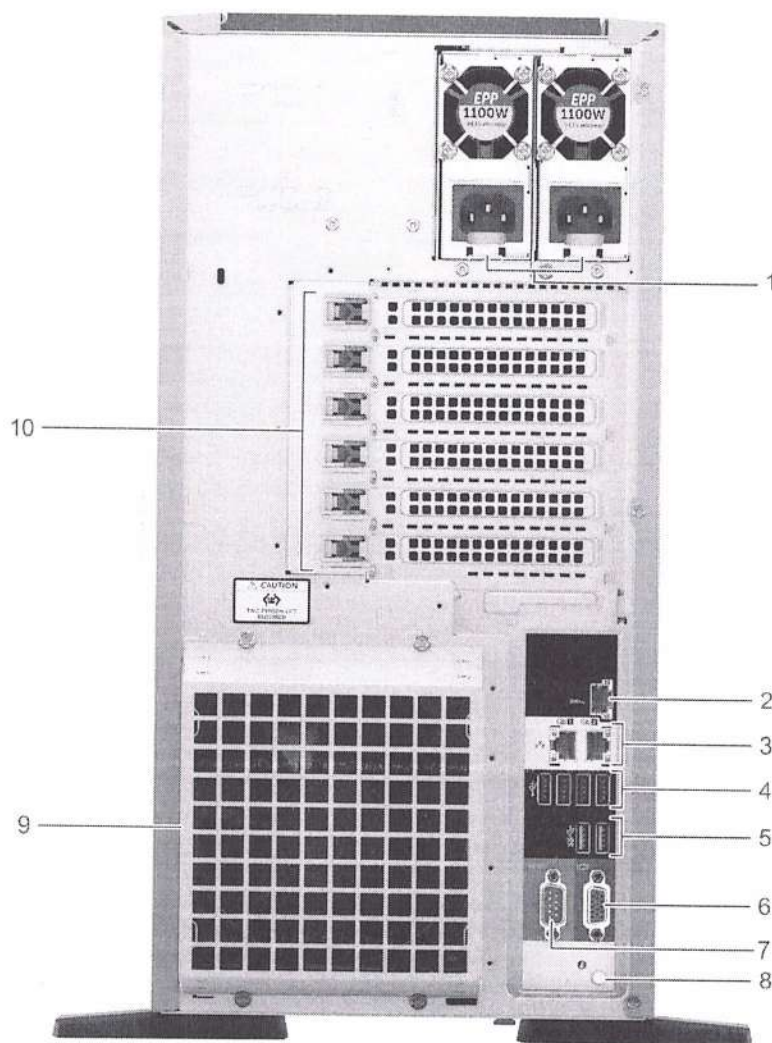


Figure 2. Back view of the system with optional redundant cooling fan

Table 4. Back view of the system features and description








Item	Ports, panels, or slots	Icon	Description
1	Power supply unit (2)	N/A	For more information about the PSU configurations, see the Technical Specifications section
2	iDRAC9 Enterprise port		Enables you to remotely access iDRAC. For more information, see the iDRAC User's Guide at <a href="http://www.dell.com/poweredgemanuals">www.dell.com/poweredgemanuals</a> .
3	NIC port (2)		The NIC ports are integrated on the system board provide network connectivity. For more information about the supported configurations, see the Technical specifications section.
4	USB 2.0 port (4)		The USB ports are 4-pin, 2.0-compliant. These ports enable you to connect USB devices to the system.
5	USB 3.0 port (2)		The USB ports are 9-pin and 3.0-compliant. These ports enable you to connect USB devices to the system.
6	VGA port		Enables you to connect a display device to the system. For more information, see the Technical specifications section.



Table 4. Back view of the system features and description (continued)

Item	Ports, panels, or slots	Icon	Description
7	Serial port		Enables you to connect a serial device to the system. For more information, see the Technical specifications section.
8	System identification button		The System Identification (ID) button is available on the front and back of the systems. Press the button to identify a system in a rack by turning on the system ID button. You can also use the system ID button to reset iDRAC and to access BIOS using the step through mode.
9	External cooling fan (optional)	N/A	Enables you to connect an optional redundant cooling fan.
10	PCIe expansion card slot	N/A	The expansion slot(s) enable you to connect PCI Express expansion cards. For more information on the expansion cards that are supported on your system, see the Expansion card guidelines.

## Internal chassis view

The chassis design of the PowerEdge T440 is optimized for easy access to components and for efficient cooling. The PowerEdge T440 supports up to 16 DIMMs, two processors, system fans, system board and hard drive bays, and many other components and features. For more system views, see the Dell EMC PowerEdge T440 Installation and Service Manual at [Dell.com/Support/Manuals](http://Dell.com/Support/Manuals).

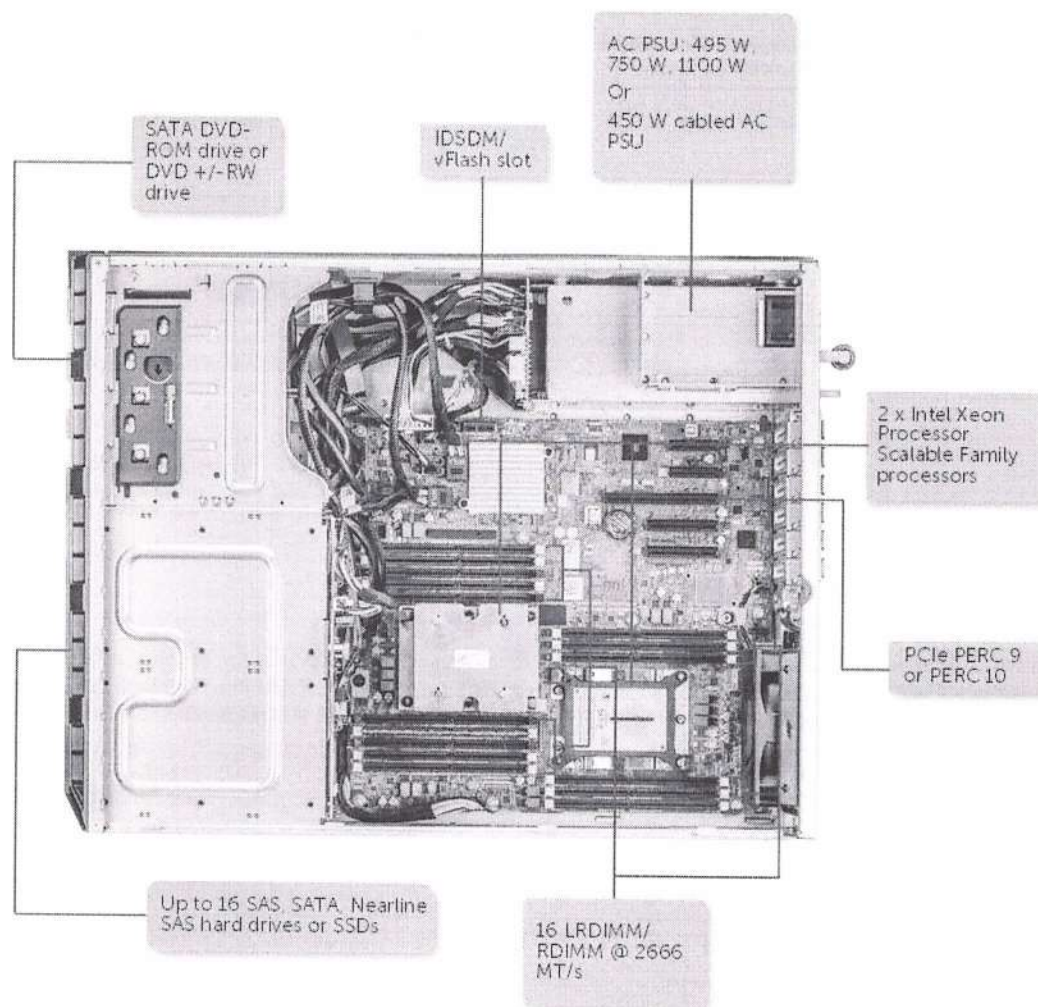


Figure 3. Supported configurations for a PowerEdge T440 system

## Security features

The latest generation of PowerEdge servers has the features listed in the table to help ensure the security of your data center.

Table 5. Security features

Security feature	Description
<b>Cover latch</b>	A toolled latch is integrated in the top cover to secure it to the system.
<b>Bezel</b>	A standard bezel is an optional metal bezel mounted to the chassis front. A lock on the bezel protects unauthorized access to hard drives.
<b>TPM</b>	The Trusted Platform Module (TPM) is used to generate/store keys, protect/authenticate passwords, and create/store digital certificates.
<b>Power-off security</b>	BIOS has the ability to disable the power button function.



## Processors

The PowerEdge T440 server features the exceptional performance, value, and power efficiency of the 2nd Generation Intel® Xeon® Scalable Processor. These processors provide high performance no matter what your constraint—floor space, power, or budget—and on workloads that range from the most complicated scientific exploration to crucial web-serving and infrastructure applications. In addition to providing raw performance gains, improved I/O is also made possible with Intel Integrated I/O, which can reduce latency by adding more lanes and doubling bandwidth. This helps to reduce network and storage bottlenecks, which improves the processor performance capabilities.

### Topics:

- Processor features
- Supported processors
- Chipset

## Processor features

The Intel Xeon Processor Scalable Family provides the foundation for a powerful datacenter platform. The key features are as follows:

- Up to 16 cores with Intel® HT Technology (2 threads/core)
- Intel® Turbo Boost technology (excludes Bronze processors)
- Between 85W-105W TDP
- 1TB/socket memory capacity on all standard 2nd generation processors.
- Socket P
- 14nm process Technology
- Rebalanced Cache Hierarchy: 1.375MB Last level Cache/core
- 2S, 4S, 8S scalable (note: 4xxx (Silver) & 3xxx (Bronze) do not support 4S or 8S platforms)
- Support for Intel AVX-512
- Intel® Ultra Path Interconnect (UPI) with bandwidth up to 10.4GT/s
- 6 Channels DDR4 per CU RDIMM, LRDIMM
- 2133, 2400, 2666 speeds at 2 DIMMs per Channel; no 3 Dimms per channel support
- MPX (Memory Protection Extensions) support
- Up to 48 PCIe lanes per CPU with x16, x8 & x4 Bifurcation support
- PCI Express 3.0 (2.5, 5.0, 8.0 GT/s)
- Separate Reference with Independent Spread Spectrum Clocking (SRIS)
- MCTP Scaling
- Per Core P-State (PCPS)
- Uncore Frequency Scaling (UFS)
- Energy Efficient Turbo (EET)
- On die PMAX detection

## Supported processors

Table 6. Supported processors for PowerEdge T440

Medal	Processor	Frequency (GHz)	Cores/Threads	Cache (M)	UPI (GT/s)	Turbo	TDP (W)
Gold	5222	3.8	4/8	16.5	10.4	Y	105
Gold	5215	2.5	10/20	13.75	10.4	Y	85
Gold	5120	2.2	14/28	19	10.4	Y	105

Table 6. Supported processors for PowerEdge T440 (continued)

Medal	Processor	Frequency (GHz)	Cores/Threads	Cache (M)	UPI (GT/s)	Turbo	TDP (W)
Gold	5118	2.3	12/24	16	10.4	Y	105
Silver	4216	2.1	16/32	22.0	9.6	Y	100
Silver	4215	2.5	8/16	11.0	9.6	Y	85
Silver	4214R	2.4	12	16.5	9.6	Y	100
Silver	4214	2.2	12	16.5	9.6	Y	85
Silver	4210R	2.4	10	13.75	9.6	Y	100
Silver	4210	2.2	10/20	13.75	9.6	Y	85
Silver	4208	2.1	8/16	11.0	9.6	Y	85
Silver	4114	2.2	10/20	14	9.6	Y	85
Silver	4112	2.6	4/24	8.25	9.6	Y	85
Silver	4110	2.1	8/16	11	9.6	Y	85
Bronze	3206R	1.9	8	11	9.6	N	85
Bronze	3204	1.9	6/6	8.25	9.6	N	85

## Chipset

The following list the features provided by the Intel® C620 chipset:

- ACPI Power Management Logic Support, Revision 4.0a
- PCI Express® Base Specification Revision 3.0
- Integrated Serial ATA host controller, supports data transfer rates of up to 6 Gb/s on all ports.
- xHCI USB controller with SuperSpeed USB 3.0 ports
- Direct Media Interface
- Serial Peripheral Interface
- Enhanced Serial Peripheral Interface
- Flexible I/O-Allows some high-speed I/O signals to be configured as PCIe® root ports, PCIe® uplink for use with certain PCH SKUs, SATA (and sSATA), or USB 3.0.
- General Purpose Input Output (GPIO)
- Low Pin Count interface, interrupt controller, and timer functions
- System Management Bus Specification, Version 2.0
- Integrated Clock Controller/Real-Time Clock Controller
- Intel® High Definition Audio and Intel® Smart Sound Technology
- Integrated 10/1 Gb Ethernet
- Integrated 10/100/1000 Mbps Ethernet MAC
- Supports Intel® Rapid Storage Technology Enterprise
- Supports Intel® Active Management Technology and Server Platform Services
- Supports Intel® Virtualization Technology for Directed I/O
- Supports Intel® Trusted Execution Technology
- JTAG Boundary Scan support
- Intel® Trace Hub for debug

## Memory

The PowerEdge T440 supports up to 1TB of memory with 16 DIMMs, and at speeds up to 2666 MT/s, providing high performance in various applications. High memory density ensures that there is no compromise in virtualization.

The PowerEdge T440 supports both registered DIMMs (RDIMM) and load-reduced DIMMs (LRDIMMs), which use a buffer to reduce memory loading and provide greater density, allowing for the maximum platform memory capacity.

The system supports:

- Up to six channels with two DPC and total 16 DIMMs
- DDR4 RDIMM/LRDIMM
- Only registered ECC DDR4 DIMMs
- DDR4 speeds up to 2666 MT/s

### DIMMs supported

Table 7. Memory technologies

Feature	RDIMM	LRDIMM
Register	Yes	Yes
Buffer	No	Yes
Frequencies	Up to 2666 MT/s	Up to 2666 MT/s
Ranks supported	Single or dual rank	Quad rank
Capacity per DIMM	4 GB, 8 GB, 16 GB or 32 GB	64 GB
Maximum DIMMs per channel	2	1, 2
DRAM technology	x4 or x8	x4
Temperature sensor	Yes	Yes
Error Correction Code (ECC)	Yes	Yes
Single Device Disable Code (SDDC)	Yes	Yes
Address parity	Yes	Yes

### Memory speed

The memory offerings for the PowerEdge T440 are based on the double-data rate type 4 (DDR4) which operates at 1.2 volts.

The T440 supports memory speeds of 2666 MT/s, 2400 MT/s, 2133 MT/s, and 1866 MT/s depending on the DIMM types installed and the configuration. All memory on all processors and channels run at the same speed and voltage. By default, this speed will be the highest speed supported by the CPU and the DIMMs. For example both DIMMs and CPUs must be capable of running at 2666 MT/s in order for memory to run at 2666 MT/s (specific CPU / DIMM configuration required). CPU SKUs in the Platinum category support up to 2666 MT/s memory speed while CPU SKUs in Gold and Silver category support up to 2400 MT/s memory speed. The operating speed of the memory is also determined by the maximum speed supported by the processor, the speed settings in the BIOS, and the operating voltage of the system.

The following table list the memory configuration and performance for the PowerEdge T440:



Table 8. DIMM performance details

DIMM type	DIMM ranking	Capacity	DIMM rated voltage, speed
RDIMM	1R/2R	8GB, 16GB, and 32GB	DDR4 (1.2v), 2666
LRDIMM	4R/8R	64GB	DDR4 (1.2v), 2666

### Topics:

- Memory population guidelines

## Memory population guidelines

Both systems support a flexible memory configuration, according to the following population guidelines:

- Speed: If DIMMs of different speeds are mixed, all channels across all processors operate at the common frequency of the slowest DIMM.
- DIMM type: Maximum two types of DIMMs allowed per system and RDIMMs are supported. RDIMM with LRDIMM cannot be mixed.
- DIMMs with different data widths can be mixed. For 14G, DIMMs with x4 and x8 data widths are supported and mixing is allowed.
- Can mix DIMMs with different capacities:
  - Population rules require the largest capacity DIMM be placed first (slot A1 populated first, then A2, and so on. The second CPU mirrors the first CPU population).
  - Maximum of two different capacity DIMMs allowed in a system
- Can mix DIMMs with different ranks:
  - Maximum of two different rank DIMMs allowed in a system

For more information on memory configuration and population, see the Dell EMC PowerEdge T440 Installation and Service Manual at [Dell.com/Support/Manuals](http://Dell.com/Support/Manuals).

## Memory RAS features

Reliability, Availability, and Serviceability (RAS) features help keep the system online and operational without significant impact to performance. RAS can decrease data loss and crashing due to errors. RAS helps in rapid, accurate diagnosis of faults that requires servicing.

Table 9. Supported RAS features

Feature	Description
Dense configuration optimized profile	Increased memory reliability can be a result from this selectable platform profile that adjusts parameters to reduce faults regarding refresh rates, speed, temperature, and voltage.
Memory demand and patrol scrubbing	Demand scrubbing is the ability to write corrected data back to the memory once a correctable error is detected on a read transaction. Patrol scrubbing proactively scans the system memory, detecting and repairing correctable errors.
Recovery from Single Device Data Correction (SDDC)	Single Device Data Correction provides error checking and correction that protects against any single memory chip failure and multi-bit errors from any portion of a single memory chip.
Failed DIMM isolation	This feature helps identify a specific failing DIMM channel pair, enabling the user to replace only the failed DIMM pair.
Memory mirroring	Memory mirroring is a method of keeping a duplicate (secondary or mirrored) copy of the contents of memory as a redundant backup for use if the primary intrasocket memory fails. The mirrored copy of the memory is stored in memory of the same processor socket.
Memory address parity protection	This feature helps detect transient errors on the address lines of the DDR channel.

**Table 9. Supported RAS features (continued)**

<b>Feature</b>	<b>Description</b>
Memory sparing—rank	Memory sparing allocates one rank per channel as a spare. If excessive correctable errors occur in a rank or channel, they are moved to the spare area while the operating system is running to prevent the errors from causing an uncorrectable failure.
Memory thermal throttling	This feature helps to optimize power/performance and can also be used to prevent DIMMs from overheating.

For information on memory mirroring and sparing configurations, see the Dell EMC PowerEdge T440 Installation and Service Manual at [Dell.com/Support/Manuals](http://Dell.com/Support/Manuals).



## Storage

The PowerEdge T440 provides scalable storage that allows you to adapt to your workload and operational requirements. With comprehensive storage options, the PowerEdge T440 offers various internal and external storage controllers, drive types, and different chassis and backplanes for varied numbers of drives. Features such as PERC H740P, and H840 RAID controllers provide vastly accelerated performance compared to the previous technologies.

### Storage controllers

The new PERC Controller offerings is a heavy leverage of previous generation PERC family. The Value Performance level controllers, carried-over from previous generation to PowerEdge T440, are a high-end offering that drives Input/Output Operations Per Second (IOPs) performance and enhance the SSD performance.

**i** NOTE: Onboard SATA ports (S140) are not accessible if mini PERC is installed.

Table 10. PERC offerings

Performance level	Description
Entry	S140—SATA
Value	HBA355e, HBA350i, H350, H730P, HBA330, H330, 12 Gb/s Ext SAS HBA
Value performance	H750, H730P
Premium performance	H750, H840, H740P

**i** NOTE: The new generation PERC 11 H750, H350, and HBA350i adapters cannot be mixed with the PERC H740P, H730P, H330, HBA330 adapters of the previous generations in one system.

**i** NOTE: Valid TBU configurations:

- HBA330 adapter can be connected to TBU and the PERC H740P, H730P, H330, HBA330 can be connected to the drive backplane.
- HBA350i adapter can be connected to TBU and the PERC H750, H350, HBA350i can be connected to the drive backplane.

### Supported drives

Table 11. Supported drives—SAS and SATA

Form Factor	Type	Speed	Rotational Speed	Capacities
2.5-inch	SATA SSD	6 Gb	N/A	120 GB Boot, 240 GB Boot, 240 GB, 400 GB, 480 GB, 800 GB, 960 GB, 1600 GB, 1920 GB, 3200 GB, 3840 GB, 7680 GB
2.5-inch	SAS SSD	12 Gb	N/A	400 GB, 480 GB, 800 GB, 960 GB, 1600 GB, 1920 GB, 3840 GB
2.5-inch	SATA	6 Gb	7.2 K	1 TB, 2 TB
2.5-inch	SAS	12 Gb	7.2 K	1 TB, 2 TB
2.5-inch	SAS	12 Gb	10 K	600 GB, 1.2 TB, 1.2 TB FIPS SED, 1.8 TB, 2.4 TB, 2.4 TB FIPS SED
2.5-inch	SAS	12 Gb	15 K	300 GB, 600 GB, 900 GB

Table 11. Supported drives—SAS and SATA (continued)

Form Factor	Type	Speed	Rotational Speed	Capacities
3.5-inch	SATA	6 Gb	7.2 K	1 TB, 2 TB, 4 TB, 8 TB, 10 TB, 12 TB, 14 TB, 16 TB
3.5-inch	SAS	12 Gb	7.2 K	2 TB, 4 TB, 8 TB, 10 TB, 12 TB, 16 TB, 4 TB FIPS SED, 8 TB FIPS SED, 12 TB FIPS SED

#### Topics:

- IDSDM or vFlash card
- Boot Optimized Storage Subsystem (BOSS)
- Optical drives

## IDSDM or vFlash card

In the PowerEdge T440 system, the IDSDM module contains the Internal Dual SD Module (IDSDM) and vFlash card that are combined into a single card module. The following are options available for PowerEdge T440 system:

- vflash only
- IDSDM only
- vflash + IDSDM

**NOTE:** The IDSDM only option is available with vFlash hardware and requires an iDRAC Enterprise license to enable this feature.

The IDSDM with vFlash module has a dedicated slot at the back of the system chassis. This is a Dell EMC-proprietary PCIe x1 slot that uses a USB 3.0 interface to host. In the PowerEdge T440 systems, the IDSDM and vFlash card size changes from SD to microSD and the supported capacity for IDSDM microSD cards are 16 GB, 32 GB, or 64 GB, while for vFlash the capacity is 16 GB only. The write-protect switch is built onboard on the IDSDM module.

## Boot Optimized Storage Subsystem (BOSS)

BOSS is offered as a means of booting 14G servers to a full OS when:

- A solution such as IDSDM may be desired, but the target OS is a full OS (not just a hypervisor)
- The user does not wish to trade off standard hot plug drive slots for OS install
- A separate hardware RAID is required for OS boot so that data drives can be in Passthrough mode with an HBA

The HW RAID BOSS card is a RAID controller with a limited feature set that presents M.2 SATA-only SSDs as either Non-RAID disks or a single RAID1 volume.

## Boot Optimized Storage Subsystem (BOSS)

BOSS is offered as a means of booting servers to a full OS in the following scenarios:

- A solution such as IDSDM may be desired, but the target OS is a full OS (not just hypervisor).
- The user does not wish to trade off the standard hot-plug hard drive slot for OS install.
- A separate hardware RAID is required for OS boot so that data drives can be in Passthrough mode with a HBA.

BOSS is a PCIe card located at the rear of the system to support up to two 80mm or 110mm M.2 SATA or PCIe x1 devices.

**NOTE:** BOSS drives are not hot-plug capable.

## Optical drives

The PowerEdge T440 supports one of the following internal optical drive options:

- DVD-ROM
- DVD

## Video

The Video Graphic Array (VGA) port enables you to connect the system to a VGA display. The T440 system supports one 15-pin VGA port at the back of the system.

Table 12. Video specifications

Resolution	Refresh Rate	Rear Panel	Front Panel
1024 x 768	60 Hz	Yes	Yes
1280 x 800	60 Hz	Yes	Yes
1280 x 1024	60 Hz	Yes	Yes
1360 x 768	60 Hz	Yes	Yes
1440 x 900	60 Hz	Yes	Yes
1600 x 900	60 Hz	Yes	Yes
1600 x 1200	60 Hz	Yes	Yes
1680 x 1050	60 Hz	Yes	Yes
1920 x 1080	60 Hz	Yes	Yes
1920 x 1200	60 Hz	Yes	Yes



## Networking and PCIe

The PowerEdge T440 offers 2 x 10GbE LOMs.

### Topics:

- PCIe expansion cards

## PCIe expansion cards

The PowerEdge T440 system has one standard PCIe connector and four Speededge connectors.

### PCIe expansion card riser configurations

Table 13. PCIe expansion card riser configurations for PowerEdge T440

PCIe slots	Height	Length	Link
Slot 1	Full height	Half length	x4
Slot 2	Full height	Half length	x4
Slot 3	Full height	Full length	x16
Slot 4	Full height	Half length	x8
Slot 5	Full height	Half length	x8

### PCIe expansion cards

Table 14. Optional add-in PCIe expansion cards for PowerEdge T440

Type	Adapter
NIC	<ul style="list-style-type: none"> <li>• Intel® PRO/1000 PT Dual Port Server Adapter, Gigabit, Copper, PCI-E x4</li> <li>• Intel® PRO/1000 VT Quad Port Server Adapter, Gigabit, Copper, PCI-E x4</li> <li>• Intel® 10GBase-T Copper Single Port NIC, PCI-E x8</li> <li>• Intel® Single Port Server Adapter, 10 Gigabit, SR Optical, PCI-E x8</li> <li>• Broadcom® BMC57710 10Base-T Cooper Single Port NIC, PCI-E x8</li> <li>• Broadcom® BMC5709C IPV6 Gigabit Copper Dual Port NIC with TOE and iSCSI Offload, PCI-E x4</li> <li>• Broadcom® BMC5709C IPV6 Gigabit Copper Dual Port NIC with TOE, PCI-E x4</li> <li>• Broadcom® NetXtreme® II 57711 Dual Port Direct Attach 10 Gb Ethernet PCI-Express Network Interface Card with TOE and iSCSI Offload</li> <li>• Intel® Gigabit ET Dual Port Server Adapter</li> <li>• Intel® Gigabit ET Quad Port Server Adapter</li> <li>• Broadcom 10 GbE NIC, Broadcom Dual Port 10 GbE SFP+</li> </ul>
HBA	<ul style="list-style-type: none"> <li>• QLogic® QLE 2462 FC4 Dual Port 4 Gbps Fiber Channel HBA</li> <li>• QLogic® QLE 220 FC4 Single Port 4 Gbps Fiber Channel HBA</li> <li>• QLogic® QLE 2460 FC4 Single Port 4 Gbps Fiber Channel HBA</li> <li>• QLogic® QLE 2562 FC8 Dual-channel HBA, PCI-E Gen 2 x4</li> <li>• QLogic® QLE 2560 FC8 Single-channel HBA, PCI-E Gen 2 x4</li> <li>• Emulex® LPe-1150 FC4 Single Port 4 Gbps Fiber Channel HBA, PCI-E x4</li> </ul>

Table 14. Optional add-in PCIe expansion cards for PowerEdge T440 (continued)

Type	Adapter
	<ul style="list-style-type: none"> <li>Emulex® LPe-11002 FC4 Dual Port 4 Gbps Fiber Channel HBA, PCI-E x4</li> <li>Emulex® LPe-12000, FC8 Single Port 4 Gbps Fiber Channel HBA, PCI-E Gen 2 x4</li> <li>Emulex® LPe-12002, FC8 Dual Port 4 Gbps Fiber Channel HBA, PCI-E Gen 2 x4</li> </ul>
CNA	<ul style="list-style-type: none"> <li>QLogic: QLE8152 HBA (10 GbE – 2 Port, PCIe Gen 2) – FCoE</li> <li>Emulex: OCE10102FM HBA (10 GbE – 2 Port, PCIe Gen 2) - FCoE</li> <li>Emulex: OCE10102IM HBA (10 GbE – 2 Port, PCIe Gen 2 – iSCSI) - iSCSI</li> <li>Broadcom 57711 NIC (10 GbE - 2 Port, PCIe Gen2) – iSOE</li> <li>Intel® DT (10 GbE – 2 Port, PCIe Gen 2) – FCoE</li> <li>Intel® DT (10 GbE – 2 Port, PCIe Gen 2) – FCoE</li> </ul>

For the latest information on all supported add-in PCIe expansion cards for the PowerEdge T440, visit the PowerEdge T440 page at Dell.com.

For more information on server network adapters, visit [www.dell.com/us/business/p/networking-cards](http://www.dell.com/us/business/p/networking-cards).



## Power, Thermal, and Acoustics

The lower overall system-level power draw is a result of the breakthrough system design developed by Dell EMC. The system aims to maximize performance per watt through a combination of energy efficient technologies, optimized thermal designs and intelligent fan control algorithms. The system fan control algorithms use an extensive array of sensors that automatically monitor power and thermal activity to minimize fan speeds based on system cooling requirements, reducing the power required for cooling.

### Topics:

- Power consumption and energy efficiency
- Thermal and Acoustics
- Power supply units
- Acoustical design

## Power consumption and energy efficiency

With the rise in the cost of energy that is coupled with increasing data center density, Dell EMC provides tools and technologies to help you realize greater performance with lower energy cost and wastage. More efficient data center usage can reduce costs by slowing the need for additional data center space. The following table lists the tools and technologies that Dell EMC offers to help you achieve your data center goals by lowering power consumption and increasing energy efficiency.

Table 15. Power tools and technologies

Feature	Description
<b>Power supply units (PSU) portfolio</b>	PSU portfolio includes intelligent features such as dynamically optimizing efficiency while maintaining availability and redundancy.
<b>Tools for right-sizing</b>	Enterprise Infrastructure Planning Tool (EIPT) is a tool that helps you to plan and tune your computer and infrastructure equipment for maximum efficiency. EIPT helps you by calculating hardware power consumption, power infrastructure, and storage. You can learn more at <a href="http://Dell.com/calc">Dell.com/calc</a>
<b>Industry compliance</b>	Dell EMC's servers are compliant with all relevant industry certifications and guidelines, including 80 PLUS, Climate Savers, and ENERGY STAR.
<b>Power monitoring accuracy</b>	PSU power monitoring improvements include: <ul style="list-style-type: none"> <li>• Power monitoring accuracy of 1%, whereas the industry standard is 5%</li> <li>• More accurate reporting of power</li> <li>• Better performance under a power cap</li> </ul>
<b>Power capping</b>	Use Dell EMC's systems management to set the power cap limit for your systems to limit the output of a PSU and reduce system power consumption. Dell is the first hardware vendor to leverage Intel Node Manager for circuit-breaker fast capping.
<b>Systems management</b>	Dell EMC's servers are compliant with all relevant industry certifications and guidelines, including 80 PLUS, Climate Savers, and ENERGY STAR.

Table 15. Power tools and technologies (continued)

Feature	Description
	Dell OpenManage Power Center delivers group power management at the rack, row, and data center level for servers, power distribution units, and uninterruptible power supplies.
<b>Active power management</b>	<p>Intel® Node Manager is an embedded technology that provides individual server- level power reporting and power limiting functionality. Dell offers a complete power management solution that is comprised of Intel Node Manager that is accessed through Dell iDRAC9 Enterprise and OpenManage Power Center that allows policy- based management of power and thermals at the individual server, rack, and data center level. Hot spare reduces power consumption of redundant power supplies.</p> <p>Thermal control of fan speed optimizes the thermal settings for your environment to reduce fan consumption and lower system power consumption. Idle power enables Dell servers to run as efficiently when idle as when at full workload.</p>
<b>Fresh Air cooling</b>	FAC is supported with certain configuration limitations. With the thermal design and reliability of Dell products, you can have the capability to operate at excursion- based temperatures beyond the industry standard of 35°C (95°F) without impacting your availability model. This solution takes into account servers, networking, storage, and other infrastructure.
<b>Rack infrastructure</b>	<p>Dell EMC offers some of the industry's highest- efficiency power infrastructure solutions, including:</p> <ul style="list-style-type: none"> <li>• Power distribution units (PDUs)</li> <li>• Uninterruptible power supplies (UPSs)</li> <li>• Energy smart containment rack enclosures</li> </ul>

## Thermal and Acoustics

The system's thermal management delivers high performance through optimized cooling of components at the lowest fan speeds across a wide range of ambient temperatures from 10°C to 35°C (50°F to 95°F) and to extended ambient temperature ranges. These optimizations result in lower fan power consumption which translate to lower system power and data center power consumption.

## Power supply units

Energy Smart power supplies have intelligent features, such as the ability to dynamically optimize efficiency while maintaining availability and redundancy. Also featured are enhanced power-consumption reduction technologies, such as high-efficiency power conversion and advanced thermal-management techniques, and embedded power-management features including high-accuracy power monitoring.

The system supports two hot-swappable AC power supplies with 1 + 1 redundancy, auto-sensing and auto-switching capability.

## Acoustical design

Dell EMC focuses on sound quality in addition to sound power level and sound pressure level. Sound quality describes how disturbing or pleasing a sound is interpreted, and Dell EMC references several psychacoustical metrics and thresholds in

delivering to it. Tone prominence is one such metric. Sound power and sound pressure levels increase with greater populations or higher utilization, while sound quality remains good even as the frequency content changes. A reference for comparison to sound pressure levels for familiar noise sources is given in the following table. An extensive description of Dell EMC Enterprise acoustical design and metrics is available in the [Dell Enterprise Acoustics](#) white paper.

**Table 16. Acoustical reference points and output comparisons**

Value measured at your ears		Equivalent familiar noise experience
LpA, dBA, re 20 $\mu$ Pa	Loudness, sones	
90	80	Loud concert
75	39	Data center, vacuum cleaner, voice must be elevated to be heard
60	10	Conversation levels
45	4	Whispering, open office layout, normal living room
35	2	Quiet office
30	1	Quiet library
20	0	Recording studio



## Rack rails

The T440 is a rack-capable tower server. When customers select rack mode chassis, T440 will support the optional sliding rail. The sliding rail system for the T440 provides tool-less support for racks with square or untreaded round mounting holes including all generations of Dell racks. The sliding rails for the T440 offers native support for threaded hole racks via the ReadyRails II mounting interface. The rails ship in the tool-less mounting configuration but can be converted to the tooled configuration very quickly and easily. An optional cable management arm (CMA) can be mounted on either the left or right side of the rails without the use of tools for fast and easy deployment.



# Dell EMC OpenManage systems management

## Dell EMC OpenManage Portfolio

Simplifying hardware management through ease of use and automation

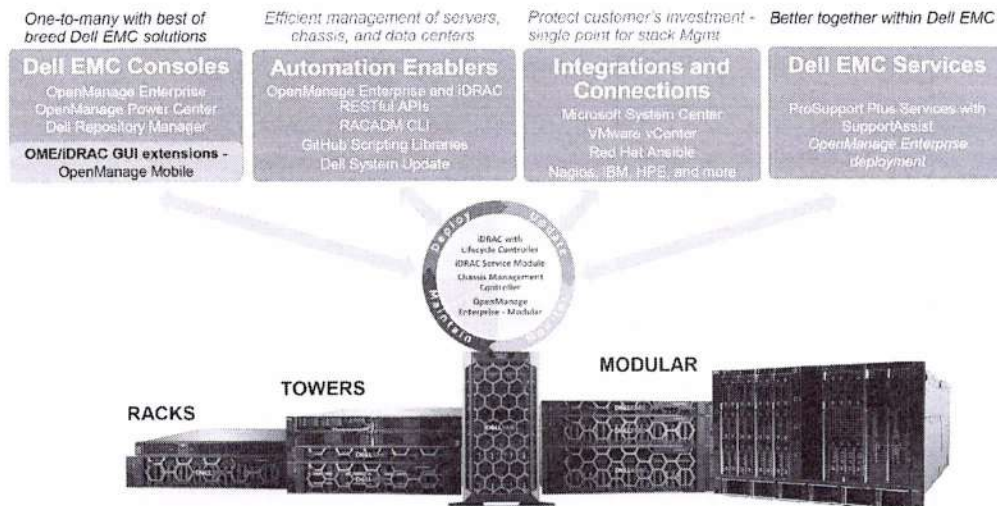


Figure 4. Dell EMC OpenManage Portfolio

Dell EMC delivers management solutions that help IT Administrators effectively deploy, update, monitor, and manage IT assets. OpenManage solutions and tools enable you to quickly respond to problems by helping them to manage Dell EMC servers effectively and efficiently; in physical, virtual, local, and remote environments, operating in-band, and out-of-band (agent-free). The OpenManage portfolio includes innovative embedded management tools such as the integrated Dell Remote Access Controller (iDRAC), Chassis Management Controller and Consoles like OpenManage Enterprise, OpenManage Power Manager plug in, and tools like Repository Manager.

Dell EMC has developed comprehensive systems management solutions based on open standards and has integrated with management consoles that can perform advanced management of Dell hardware. Dell EMC has connected or integrated the advanced management capabilities of Dell hardware into offerings from the industry's top systems management vendors and frameworks such as Ansible, thus making Dell EMC platforms easy to deploy, update, monitor, and manage.

The key tools for managing Dell EMC PowerEdge servers are iDRAC and the one-to-many OpenManage Enterprise console. OpenManage Enterprise helps the system administrators in complete lifecycle management of multiple generations of PowerEdge servers. Other tools such as Repository Manager, which enables simple yet comprehensive change management.

OpenManage tools integrate with systems management framework from other vendors such as VMware, Microsoft, Ansible, and ServiceNow. This enables you to use the skills of the IT staff to efficiently manage Dell EMC PowerEdge servers.

### Topics:

- iDRAC with Lifecycle controller
- Server and Chassis Managers
- Dell EMC consoles
- Automation Enablers
- Integration with third party consoles
- Connections for third-party consoles
- Dell EMC Update Utilities
- Dell resources

## iDRAC with Lifecycle controller

The integrated Dell Remote Access Controller 9 (iDRAC9) with Lifecycle Controller is embedded within every Dell EMC PowerEdge server and provides functionality that helps IT administrators deploy, update, monitor, and maintain servers with no need for any additional software to be installed. iDRAC functions regardless of operating system or hypervisor presence because from a pre-OS or bare-metal state, iDRAC is ready to work because it is embedded within each server from the factory.

### iDRAC features and comparison

The T440 supports the following iDRAC licenses – Basic (default), Express (upgrade) and Enterprise (upgrade).

Table 17. iDRAC feature comparison

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
<b>Interfaces / Standards</b>					
iDRAC RESTful API and Redfish	Yes	Yes	Yes	Yes	Yes
IPMI 2.0	Yes	Yes	Yes	Yes	Yes
DCMI 1.5	Yes	Yes	Yes	Yes	Yes
Web-based GUI	Yes	Yes	Yes	Yes	Yes
RACADM command line (local/remote)	Yes	Yes	Yes	Yes	Yes
SMASH-CLP (SSH-only)	Yes	Yes	Yes	Yes	Yes
Telnet	Yes	Yes	Yes	Yes	Yes
SSH	Yes	Yes	Yes	Yes	Yes
Serial Redirection	Yes	Yes	Yes	Yes	Yes
WSMan	Yes	Yes	Yes	Yes	Yes
Network Time Protocol	No	Yes	Yes	Yes	Yes
<b>Connectivity</b>					
Shared NIC (LOM)	Yes	Yes	N/A	Yes	Yes
Dedicated NIC	Yes	Yes	Yes	Yes	Yes
VLAN tagging	Yes	Yes	Yes	Yes	Yes
IPv4	Yes	Yes	Yes	Yes	Yes
IPv6	Yes	Yes	Yes	Yes	Yes
DHCP	Yes	Yes	Yes	Yes	Yes
DHCP with zero touch	No	No	No	Yes	Yes
Dynamic DNS	Yes	Yes	Yes	Yes	Yes
OS pass-through	Yes	Yes	Yes	Yes	Yes
iDRAC Direct -Front panel USB	Yes	Yes	Yes	Yes	Yes
Connection View	Yes	Yes	No	Yes	Yes



Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Connection View - LLDP transmit	No	No	No	No	Yes
<b>Security</b>					
Role-based authority	Yes	Yes	Yes	Yes	Yes
Local users	Yes	Yes	Yes	Yes	Yes
SSL encryption	Yes	Yes	Yes	Yes	Yes
Secure Enterprise Key Manager	No	No	No	Yes (with SEKM license)	Yes (with SEKM license)
IP blocking	No	Yes	Yes	Yes	Yes
Directory services (AD, LDAP)	No	No	No	Yes	Yes
Two-factor authentication (smart card)	No	No	No	Yes	Yes
Single sign-On	No	No	No	Yes	Yes
PK authentication (for SSH)	No	Yes	Yes	Yes	Yes
FIPS 140-2	Yes	Yes	Yes	Yes	Yes
Secure UEFI boot - certificate management	Yes	Yes	Yes	Yes	Yes
Lock down mode	No	No	No	Yes	Yes
Unique iDRAC default password	Yes	Yes	Yes	Yes	Yes
Customizable Security Policy Banner - login page	Yes	Yes	Yes	Yes	Yes
Easy Multi Factor Authentication	No	No	No	No	Yes
Auto Certificate Enrollment (SSL Certs)	No	No	No	No	Yes
iDRAC Quick Sync 2 - optional auth for read operations	Yes	Yes	Yes	Yes	Yes
iDRAC Quick Sync 2 - add mobile device number to LCL	Yes	Yes	Yes	Yes	Yes
System Erase of internal storage devices	Yes	Yes	Yes	Yes	Yes
<b>Remote Presence</b>					
Power control	Yes	Yes	Yes	Yes	Yes

Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Boot control	Yes	Yes	Yes	Yes	Yes
Serial-over-LAN	Yes	Yes	Yes	Yes	Yes
Virtual Media	No	No	Yes	Yes	Yes
Virtual Folders	No	No	No	Yes	Yes
Remote File Share	No	No	No	Yes	Yes
HTML5 access to Virtual Console	No	No	Yes	Yes	Yes
Virtual Console	No	No	Yes	Yes	Yes
VNC connection to OS	No	No	No	Yes	Yes
Quality/bandwidth control	No	No	No	Yes	Yes
Virtual Console collaboration (up to six simultaneous users)	No	No	No (One user only)	Yes	Yes
Virtual Console chat	No	No	No	Yes	Yes
Virtual Flash partitions	No	No	No	Yes	Yes
<b>NOTE: vFlash is not available in iDRAC9 for PowerEdge Rx5xx/Cx5xx.</b>					
Group Manager	No	No	No	Yes	Yes
HTTP / HTTPS support along with NFS/CIFS	Yes	Yes	Yes	Yes	Yes
<b>Power and Thermal</b>					
Real-time power meter	Yes	Yes	Yes	Yes	Yes
Power thresholds and alerts	No	Yes	Yes	Yes	Yes
Real-time power graphing	No	Yes	Yes	Yes	Yes
Historical power counters	No	Yes	Yes	Yes	Yes
Power capping	No	No	No	Yes	Yes
Power Center integration	No	No	No	Yes	Yes
Temperature monitoring	Yes	Yes	Yes	Yes	Yes
Temperature graphing	No	Yes	Yes	Yes	Yes
PCIe airflow customization (LFM)	No	No	No	No	Yes



Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Custom Exhaust Control	No	No	No	No	Yes
Custom Delta-T control	No	No	No	No	Yes
System Airflow Consumption	No	No	No	No	Yes
Custom PCIe inlet temperature	No	No	No	No	Yes
<b>Health Monitoring</b>					
Full agent-free monitoring	Yes	Yes	Yes	Yes	Yes
Predictive failure monitoring	Yes	Yes	Yes	Yes	Yes
SNMPv1, v2, and v3 (traps and gets)	Yes	Yes	Yes	Yes	Yes
Email Alerting	No	Yes	Yes	Yes	Yes
Configurable thresholds	Yes	Yes	Yes	Yes	Yes
Fan monitoring	Yes	Yes	Yes	Yes	Yes
Power Supply monitoring	Yes	Yes	Yes	Yes	Yes
Memory monitoring	Yes	Yes	Yes	Yes	Yes
CPU monitoring	Yes	Yes	Yes	Yes	Yes
RAID monitoring	Yes	Yes	Yes	Yes	Yes
NIC monitoring	Yes	Yes	Yes	Yes	Yes
HD monitoring (enclosure)	Yes	Yes	Yes	Yes	Yes
Out of Band Performance Monitoring	No	No	No	Yes	Yes
Alerts for excessive SSD wear	Yes	Yes	Yes	Yes	Yes
Customizable settings for Exhaust Temperature	Yes	Yes	Yes	Yes	Yes
Serial Console Logs	No	No	No	No	Yes
SMART logs for Storage Drives	No	No	No	No	Yes
Idle Server detection	No	No	No	No	Yes
Telemetry Streaming	No	No	No	No	Yes
<b>Update</b>					

Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Remote agent-free update	Yes	Yes	Yes	Yes	Yes
Embedded update tools	Yes	Yes	Yes	Yes	Yes
Update from repository (Auto-Update)	No	No	No	Yes	Yes
Schedule update from repository	No	No	No	Yes	Yes
Improved PSU firmware updates	Yes	Yes	Yes	Yes	Yes
<b>Deployment and Configuration</b>					
Local configuration via F10	Yes	Yes	Yes	Yes	Yes
Embedded OS deployment tools	Yes	Yes	Yes	Yes	Yes
Embedded configuration tools	Yes	Yes	Yes	Yes	Yes
Auto-Discovery	No	Yes	Yes	Yes	Yes
Remote OS deployment	No	Yes	Yes	Yes	Yes
Embedded driver pack	Yes	Yes	Yes	Yes	Yes
Full configuration inventory	Yes	Yes	Yes	Yes	Yes
Inventory export	Yes	Yes	Yes	Yes	Yes
Remote configuration	Yes	Yes	Yes	Yes	Yes
Zero-touch configuration	No	No	No	Yes	Yes
System Retire/Repurpose	Yes	Yes	Yes	Yes	Yes
Server Configuration Profile in GUI	Yes	Yes	Yes	Yes	Yes
Add BIOS configuration to iDRAC GUI	Yes	Yes	Yes	Yes	Yes
<b>Diagnostics, Service, and Logging</b>					
Embedded diagnostic tools	Yes	Yes	Yes	Yes	Yes
Part Replacement	No	Yes	Yes	Yes	Yes
<b>NOTE: After performing part replacement on RAID hardware, and the process is complete for replacing firmware and configuration, Lifecycle Logs reports double part replacement entries which is expected behavior.</b>					

Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Server Configuration Backup	No	No	No	Yes	Yes
Easy Restore (system configuration)	Yes	Yes	Yes	Yes	Yes
Server Configuration Restore	Yes	Yes	Yes	Yes	Yes
Easy Restore Auto Timeout	Yes	Yes	Yes	Yes	Yes
<b>NOTE: Server Backup and Restore features are not available in iDRAC9 for PowerEdge Rx5xx/Cx5xx.</b>					
LED Health status indicators	Yes	Yes	N/A	Yes	Yes
LCD screen (iDRAC9 requires optional)	Yes	Yes	N/A	Yes	Yes
Quick Sync (require NFC bezel, 13G only)	N/A	N/A	N/A	N/A	Yes
iDRAC Quick Sync 2 (BLE/Wi-Fi hardware)	Yes	Yes	Yes	Yes	Yes
iDRAC Direct (front USB management port)	Yes	Yes	Yes	Yes	Yes
iDRAC Service Module (iSM) embedded	Yes	Yes	Yes	Yes	Yes
iSM to in-band alert forwarding to consoles	Yes	Yes	Yes	Yes	Yes
SupportAssist Collection (embedded)	Yes	Yes	Yes	Yes	Yes
Crash screen capture	No	Yes	Yes	Yes	Yes
Crash video capture 1	No	No	No	Yes	Yes
Agent Free Crash Video Capture (Windows only)	No	No	No	No	Yes
Boot capture	No	No	No	Yes	Yes
Manual reset for iDRAC (LCD ID button)	Yes	Yes	Yes	Yes	Yes



Table 17. iDRAC feature comparison (continued)

Feature	iDRAC9 Basic	iDRAC9 Express	iDRAC9 Express for Blades	iDRAC9 Enterprise	iDRAC9 Datacenter
Remote reset for iDRAC (requires iSM)	Yes	Yes	Yes	Yes	Yes
Virtual NMI	Yes	Yes	Yes	Yes	Yes
OS watchdog	Yes	Yes	Yes	Yes	Yes
System Event Log	Yes	Yes	Yes	Yes	Yes
Lifecycle Log	Yes	Yes	Yes	Yes	Yes
Enhanced Logging in Lifecycle Controller Log	Yes	Yes	Yes	Yes	Yes
Work notes	Yes	Yes	Yes	Yes	Yes
Remote Syslog	No	No	No	Yes	Yes
License management	Yes	Yes	Yes	Yes	Yes
<b>Improved Customer Experience</b>					
iDRAC -Faster processor, more memory	N/A	Yes	N/A	Yes	Yes
GUI rendered in HTML5	N/A	Yes	N/A	Yes	Yes
Add BIOS configuration to iDRAC GUI	N/A	Yes	N/A	Yes	Yes
iDRAC support for SW RAID licensing	N/A	Yes	N/A	Yes	Yes

## Server and Chassis Managers

- Integrated Dell Remote Access Controller (iDRAC)
- iDRAC Service Module (iSM)

## Dell EMC consoles

- Dell EMC OpenManage Enterprise
- Dell EMC Repository Manager (DRM)
- Dell EMC OpenManage Enterprise Power Manager plugin to OpenManage Enterprise
- Dell EMC OpenManage Mobile (OMM)

## Automation Enablers

- OpenManage Ansible Modules
- iDRAC RESTful APIs (Redfish)
- Standards-based APIs (Python, PowerShell)
- RACADM Command Line Interface (CLI)
- GitHub Scripting Libraries



## Integration with third-party consoles

- Dell EMC OpenManage Integrations with Microsoft System Center
- Dell EMC OpenManage Integration for VMware vCenter (OMIVV)
- Dell EMC OpenManage Ansible Modules
- Dell EMC OpenManage Integration with ServiceNow

## Connections for third-party consoles

- Micro Focus and other HPE tools
- OpenManage Connection for IBM Tivoli
- OpenManage Plug-in for Nagios Core and XI

## Dell EMC Update Utilities

- Dell System Update (DSU)
- Dell EMC Repository Manager (DRM)
- Dell EMC Update Packages (DUP)
- Dell EMC Server Update Utility (SUU)
- Dell EMC Platform Specific Bootable ISO (PSBI)

## Dell resources

For additional information about white papers, videos, blogs, forums, technical material, tools, usage examples, and other information, go to the OpenManage page at <https://www.dell.com/openmanagemanuals> or the following product pages:

**Table 18. Dell resources**

Resource	Location
Integrated Dell Remote Access Controller (iDRAC)	<a href="https://www.dell.com/idracmanuals">https://www.dell.com/idracmanuals</a>
iDRAC Service Module (iSM)	<a href="https://www.dell.com/support/article/sln310557">https://www.dell.com/support/article/sln310557</a>
OpenManage Ansible Modules	<a href="https://www.dell.com/support/article/sln310720">https://www.dell.com/support/article/sln310720</a>
OpenManage Essentials (OME)	<a href="https://www.dell.com/support/article/sln310714">https://www.dell.com/support/article/sln310714</a>
OpenManage Mobile (OMM)	<a href="https://www.dell.com/support/article/sln310980">https://www.dell.com/support/article/sln310980</a>
OpenManage Integration for VMware vCenter (OMIVV)	<a href="https://www.dell.com/support/article/sln311238">https://www.dell.com/support/article/sln311238</a>
OpenManage Integration for Microsoft System Center (OMIMSSC)	<a href="https://www.dell.com/support/article/sln312177">https://www.dell.com/support/article/sln312177</a>
Dell EMC Repository Manager (DRM)	<a href="https://www.dell.com/support/article/sln312652">https://www.dell.com/support/article/sln312652</a>
Dell EMC System Update (DSU)	<a href="https://www.dell.com/support/article/sln310654">https://www.dell.com/support/article/sln310654</a>
Dell EMC Platform Specific Bootable ISO (PSBI)	<a href="https://www.dell.com/support/article/sln296511">Dell.com/support/article/sln296511</a>
Dell EMC Chassis Management Controller (CMC)	<a href="https://www.dell.com/support/article/sln311283">www.dell.com/support/article/sln311283</a>
OpenManage Connections for Partner Consoles	<a href="https://www.dell.com/support/article/sln312320">https://www.dell.com/support/article/sln312320</a>
OpenManage Enterprise Power Manager	<a href="https://www.dell.com/solutions/openmanage/power-management.htm">https://www.dell.com/solutions/openmanage/power-management.htm</a>
OpenManage Integration with ServiceNow (OMISNOW)	<a href="https://www.dell.com/support/article/sln317784">Dell.com/support/article/sln317784</a>

**NOTE:** Features may vary by server. Please refer to the product page on <https://www.dell.com/manuals> for details.

## Appendix A. Additional specifications

### Topics:

- PSU specifications
- System dimensions
- Environmental specifications
- Video specifications
- USB ports

### PSU specifications

PowerEdge T440 support that up to 2 AC or DC power supplies with 1+1 redundancy, auto sensing and auto-switching capability. The PowerEdge T440 system supports the following AC redundant power supply units (PSU).

Table 19. PSU specifications

PSU	Class	Heat dissipation (maximum)	Frequency	Voltage
1100 W AC	Platinum	4100 BTU/hr	50/60 Hz	100–240 V AC, autoranging
750 W AC	Platinum	2891 BTU/hr	50/60 Hz	100–240 V AC, autoranging
750 W AC (Mixed Mode)	Platinum	2891 BTU/hr	50/60 Hz	100-240Vac/10-5A
495 W AC	Platinum	1908 BTU/hr	50/60 Hz	100–240 V AC, autoranging
450 W AC	Bronze	7871 BTU/hr	50/60 Hz	100–240 V AC, cabled PSU

**NOTE:** If a system with AC 1100 W PSUs operate at low line 100-120 Vac, then the power rating per PSU is derated to 1050 W.

# System dimensions

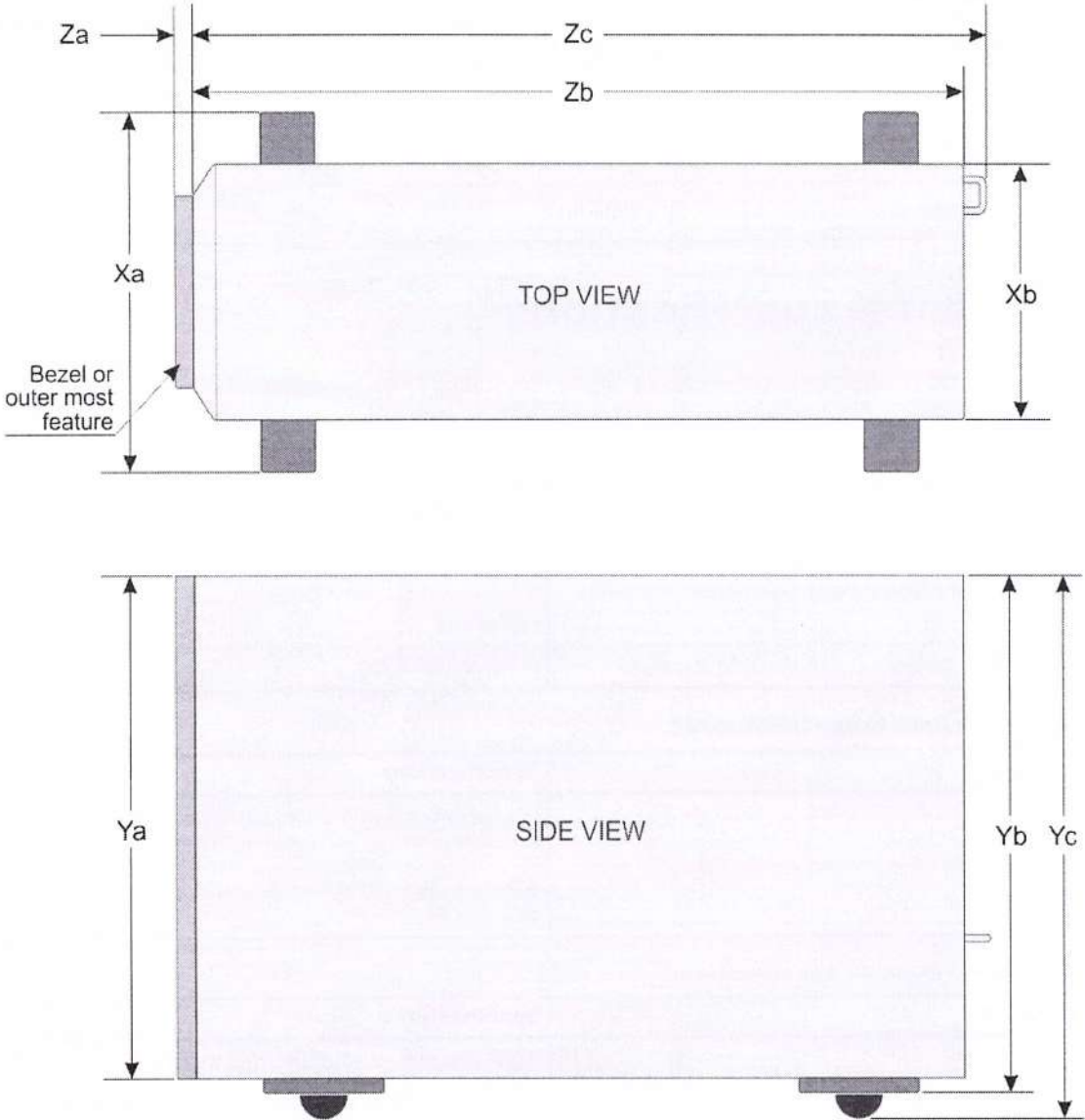


Figure 5. Details the dimensions of the PowerEdge T440 system

Table 20. Dimensions of PowerEdge T440 system

Xa	Xb	Ya	Yb	Yc	Za	Zb	Zc
307.9 mm (12.12 in)	218 mm (8.58 in)	430.3 mm (16.94 in)	464.362 mm (18.28 in)	471.333 mm (17.37 in)	(with bezel) 37.065 mm (1.45 in)	538.4 mm (21.19 in)	573.636 mm (22.58 in)
					(without bezel) 21.165 mm (0.83 in)		



## Chassis weight

Table 21. Chassis weight

System configuration	Maximum weight
4 x 3.5 inch drive system	23.9 Kg (52.69 lb)
8 x 3.5 inch drive system	29.5 Kg (65.03 lb)
16 x 2.5 inch drive system	27.7 Kg (61.06 lb)

## Environmental specifications

The table below shows the environmental specifications for the PowerEdge T440. For additional information refer to [dell.com/environmental\\_datasheets](http://dell.com/environmental_datasheets)

Table 22. Temperature specifications

Temperature	Specifications
Storage	-40°C to 65°C (-40°F to 149°F)
Continuous operation(for altitude less than 950m or 3117ft)	10°C to 35°C (50°F to 95°F) with no direct sunlight on the equipment
Maximum temperature gradient (operating and storage)	20°C/h (68°F/h)

Table 23. Relative humidity specifications

Relative Humidity	Specifications
Storage	5% to 95% RH with 33°C (91°F) maximum dew point. Atmosphere must be non-condensing at all times.
Operating	10% to 80% relative humidity with 29°C (84.2°F) maximum dew point.

Table 24. Maximum vibration specifications

Maximum vibration	Specifications
Operating	0.26Grms at 5Hz to 350Hz (all three axes)
Storage	1.88Grms at 10Hz to 500Hz for 15min (all six sides tested)

Table 25. Maximum shock specifications

Maximum shock	Specifications
Operating	Six consecutively executed shock pulses in the positive and negative x, y, and z axes of 6G for up to 11ms
Storage	Six consecutively executed shock pulses in the positive and negative x, y, and z axes (one pulse on each side of the system) of 71 G for up to 2 ms.

Table 26. Maximum altitude specifications

Maximum altitude	Specifications
Operating	3048m (10,000 ft)
Storage	12,000m (39,370 ft)



Table 27. Operating temperature de-rating specifications

Operating temperature de-rating	Specifications
Up to 35°C (95°F)	Maximum temperature is reduced by 1°C/300 m (1°F/547 ft) above 950 m (3,117 ft).
35°C to 40°C (95°F to 104°F)	Maximum temperature is reduced by 1°C/175 m (1°F/319 ft) above 950 m (3,117 ft).
40°C to 45°C (104°F to 113°F)	Maximum temperature is reduced by 1°C/125 m (1°F/228 ft) above 950 m (3,117 ft).

Table 28. Standard operating temperature specifications

Standard operating temperature	Specifications
Continuous operation (for altitude less than 950m or 3117ft)	10°C to 35°C (50°F to 95°F) with no direct sunlight on the equipment.

Table 29. Expanded operating temperature specifications

Expanded operating temperature	Specifications
Continuous operation	<p>5°C to 40°C at 5% to 85% RH with 29°C dew point.</p> <p><b>NOTE:</b></p> <p>Outside the standard operating temperature (10°C to 35°C), the system can operate continuously in temperatures as low as 5°C and as high as 40°C.</p> <p>For temperatures between 35°C and 40°C, de- rate maximum allowable temperature by 1°C per 175 m above 950 m (1°F per 319 ft).</p>
≤ 1% of annual operating hours	<p>-5°C to 45°C at 5% to 90% RH with 29°C dew point.</p> <p><b>NOTE:</b></p> <p>Outside the standard operating temperature (10°C to 35°C), the system can operate down to -5°C or up to 45°C for a maximum of 1% of its annual operating hours.</p> <p>For temperatures between 40°C and 45°C, de- rate maximum allowable temperature by 1°C per 125 m above 950 m (1°F per 228 ft).</p>

Table 30. Particulate contamination specifications

Particulate contamination	Specifications
<b>Air filtration</b>	<p>Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit.</p> <p><b>NOTE:</b> This condition applies to data center environments only. Air filtration requirements do not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor.</p> <p><b>NOTE:</b> Air entering the data center must have MERV11 or MERV13 filtration.</p>
<b>Conductive dust</b>	<p>Air must be free of conductive dust zinc whiskers, or other conductive particles.</p> <p><b>NOTE:</b> This condition applies to data center and non-data center environments.</p>
<b>Corrosive dust</b>	<ul style="list-style-type: none"> <li>Air must be free of corrosive dust.</li> <li>Residual dust present in the air must have a deliquescent point less than 60% relative humidity.</li> </ul>

Table 30. Particulate contamination specifications (continued)

Particulate contamination	Specifications
	NOTE: This condition applies to data center and non-data center environments.

Table 31. Gaseous contamination specifications

Gaseous contamination	Specification
Copper coupon corrosion rate	<300A/month per class G1 as defines by ANSI/ISA71.04-1985
Silver coupon corrosion rate	<200A/month as defined by ASHRAE TC9.9

## Video specifications

The PowerEdge T440 system supports the Integrate Matrox G200 graphics card with iDRAC9. The following table lists the video technical specifications:

Table 32. Video specifications

Resolution	Refresh rate	Horizontal frequency	Pixel clock	Rear panel	Front panel	DVO DisplayPort
1024 x 768	60 Hz	48.4 kHz	65.0 MHz	Yes	Yes	Yes
1280 x 800	60 Hz	49.7 kHz	83.5 MHz	Yes	Yes	Yes
1280 x 1024	60 Hz	64.0 kHz	108.0 MHz	Yes	Yes	Yes
1360 x 768	60 Hz	47.71 kHz	85.5 MHz	Yes	Yes	Yes
1440 x 900	60 Hz	55.9 kHz	106.5 MHz	Yes	Yes	Yes
1600 x 900	60 Hz	55.54 kHz	97.75 MHz	Yes	Yes	Yes
1600 x 1200	60 Hz	75.0 kHz	162.0 MHz	Yes	Yes	Yes
1680 x 1050	60 Hz	64.7 kHz	119.0 MHz	Yes	Yes	Yes
1920 x 1080	60 Hz	67.158 kHz	173.0 MHz	Yes	No	No
1920 x 1200	60 Hz	74.556 kHz	193.25 MHz	Yes	No	No

## USB ports

The table provides information about the supported USB port specifications.

Table 33. USB specifications

System	Front panel	Back panel
PowerEdge T440	<ul style="list-style-type: none"> <li>One USB 2.0-compliant port</li> <li>One USB 3.0-compliant port</li> </ul>	<ul style="list-style-type: none"> <li>Four USB 2.0-compliant rear ports</li> <li>Two USB 3.0-compliant rear ports</li> </ul>